

FORM PTO-1449
INFORMATION DISCLOSURE CITATIONS
IN AN APPLICATION

Atty Docket: 01-446
Applicant: Zhu, Wang
Filing Date: 2001.09.28

Serial #:
Group:

U.S. PATENT DOCUMENTS

Examiner Initial	Cite #	Document Number	Date	Name	Class	Sub-Class	Filing Date
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FOREIGN PATENT DOCUMENTS

Examiner Initial	Cite #	Document Number	Date	Country	Class	Sub-Class	Translation
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OTHER NON-PATENT DOCUMENTS

Examiner Initial	Cite #	Author, title, date, pertinent pages, etc.
CS	1	S. Gandikota, et al., "Extension of Copper Plating to 0.13 micron Nodes by Pulse-Modulated Plating," Proceedings of The International Interconnect Technology Conference, California, June 2000.

Examiner	Date Considered:
Sama Wang	8/26/03

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to Applicant.

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